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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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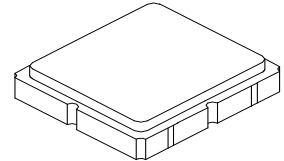
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RF3608D

**426.4 MHz
SAW Filter**



SM3838-8

- 418.00 to 434.79 MHz Filter
- Optimized for use with the TRC105 Transceiver
- Balanced 150 ohm IC Interface
- Complies with Directive 2002/95/EC (RoHS) 

Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	+15	dBm
DC Voltage	±5	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_C			426.4		MHz
1 dB Bandwidth	BW_1			19.5		MHz
Maximum Insertion Loss, 418.00 to 434.79 MHz	IL_{MAX}			1.8	2.8	dB
Amplitude Ripple, p-p, 418 to 434.79 MHz					1.0	
Rejection Referenced to Insertion Loss at 433.00 MHz:						
DC to 406 MHz			40	43		
456 to 470 MHz			33	36		
470 to 870 MHz			40	43		
870 to 1300 MHz			37	40		
1300 to 1735 MHz			29	32		
1735 to 2000 MHz			24	27		
Source Impedance	Z_S			50		Ω
Balanced Load Impedance	Z_L			150		Ω

Case Style	SM3838-8 3.8 x 3.8 mm Nominal Footprint	
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	891, YWWS	
Standard Reel Quantity	Reel Size 7 Inch	500 Pieces/Reel
	Reel Size 13 Inch	3000 Pieces/Reel

Electrical Connections

Connection	Terminals
Single-ended Port	6
Balanced Port	1, 3
Case Ground	4, 5, 7, 8
No Connection	2

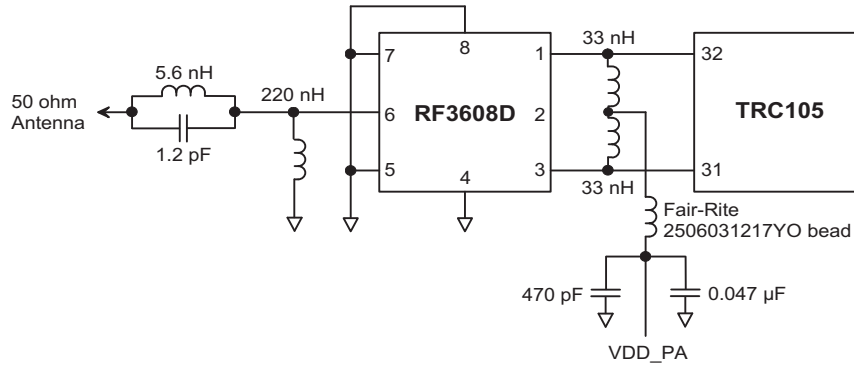


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

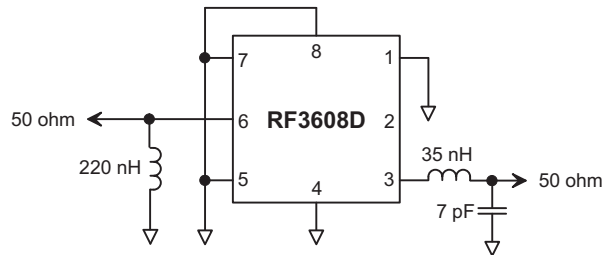
NOTES:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, f_C .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. The design, manufacturing process, and specifications of this filter are subject to change.
5. US and international patents may apply.
6. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

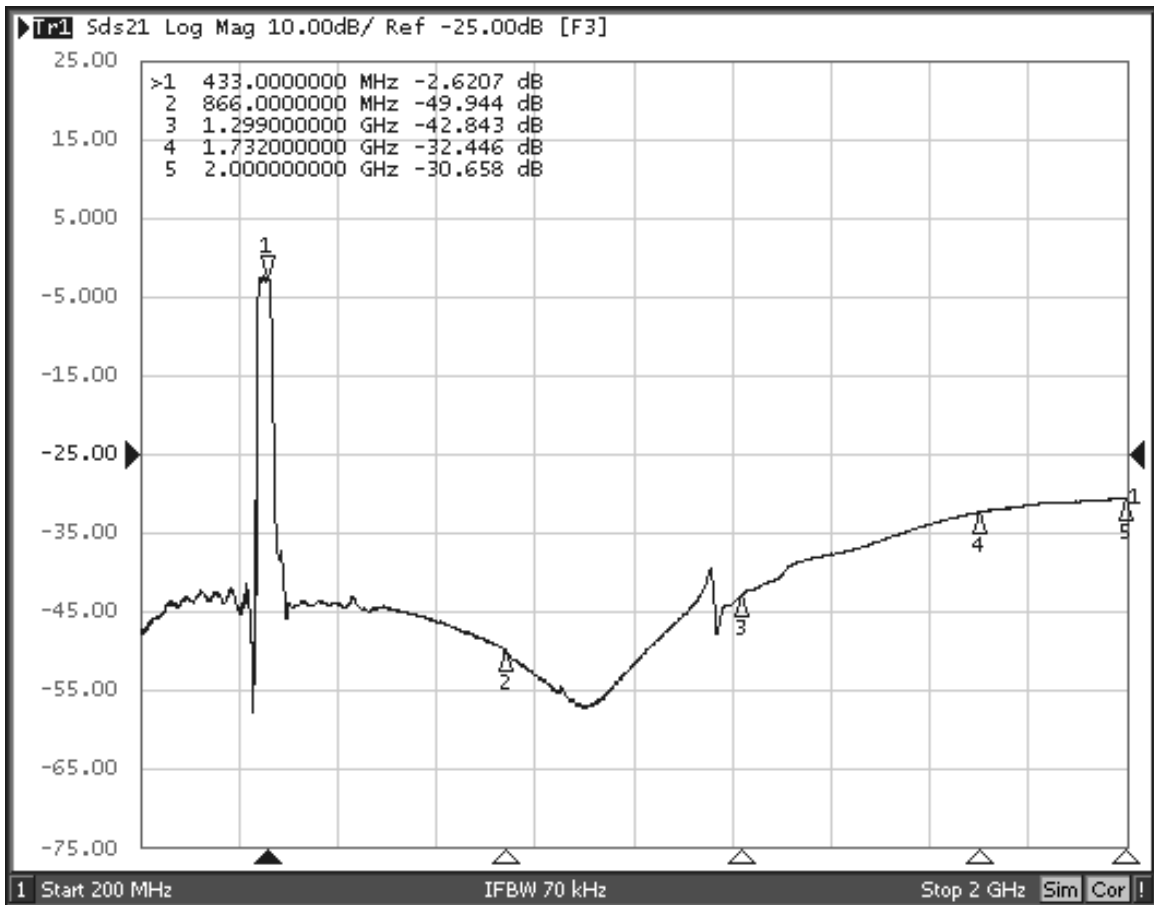
RF3608D-TRC105 Application Circuit



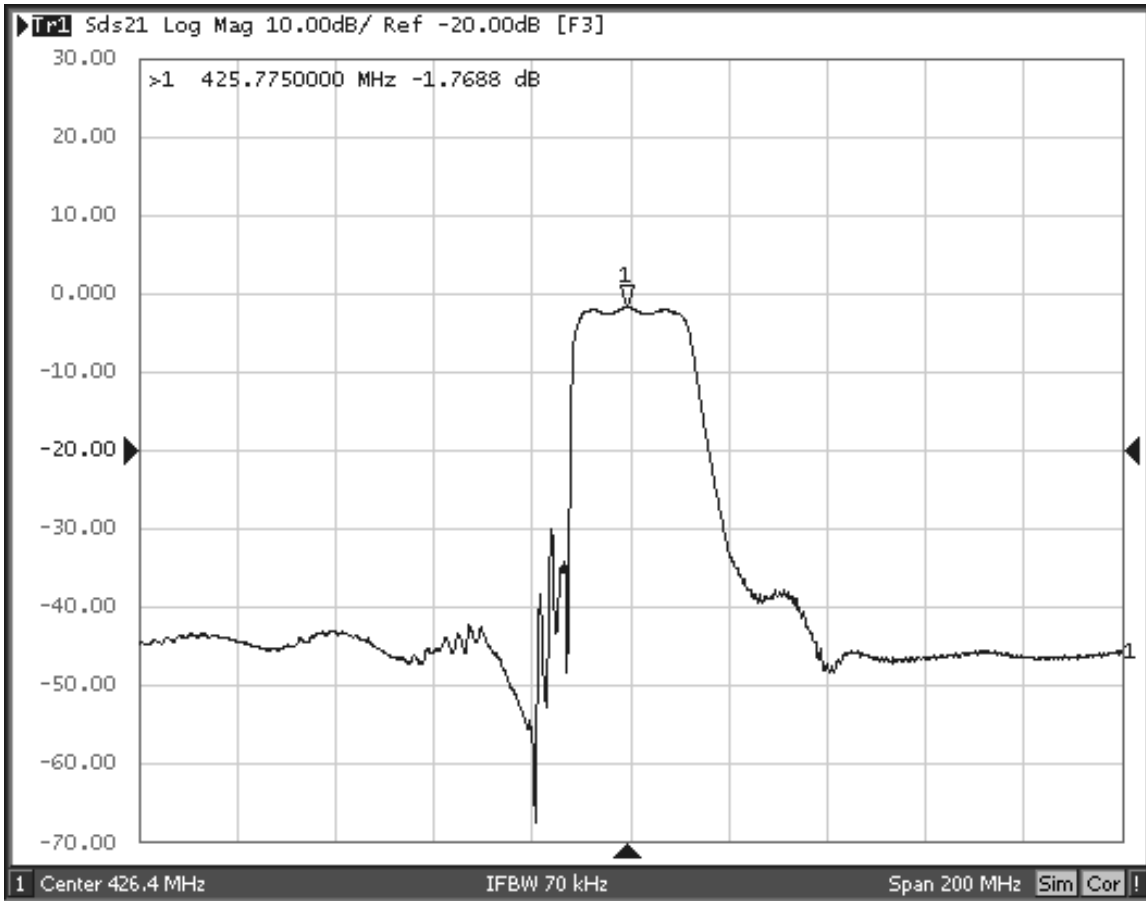
RF3608D 50 Ohm Tuning Network



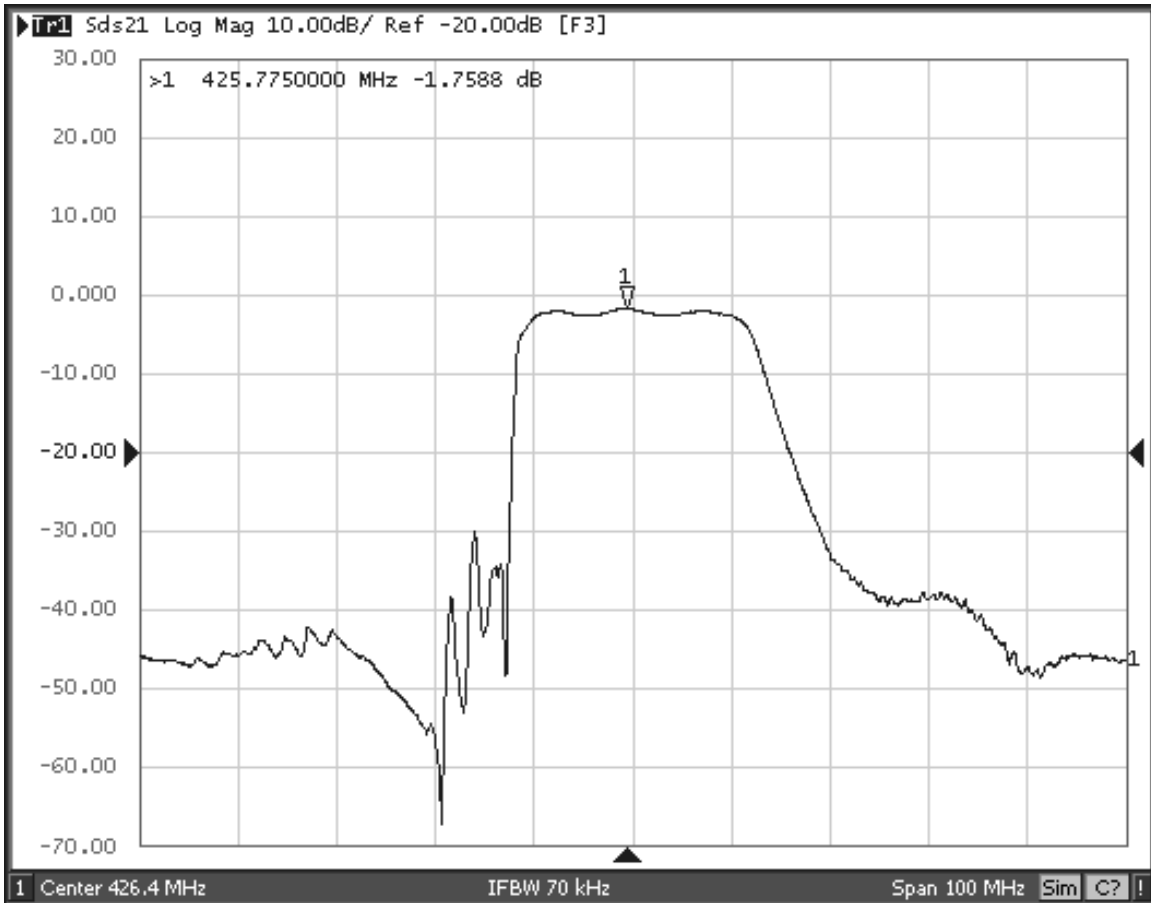
RF3608D Broadband Response, 200 to 2000 MHz



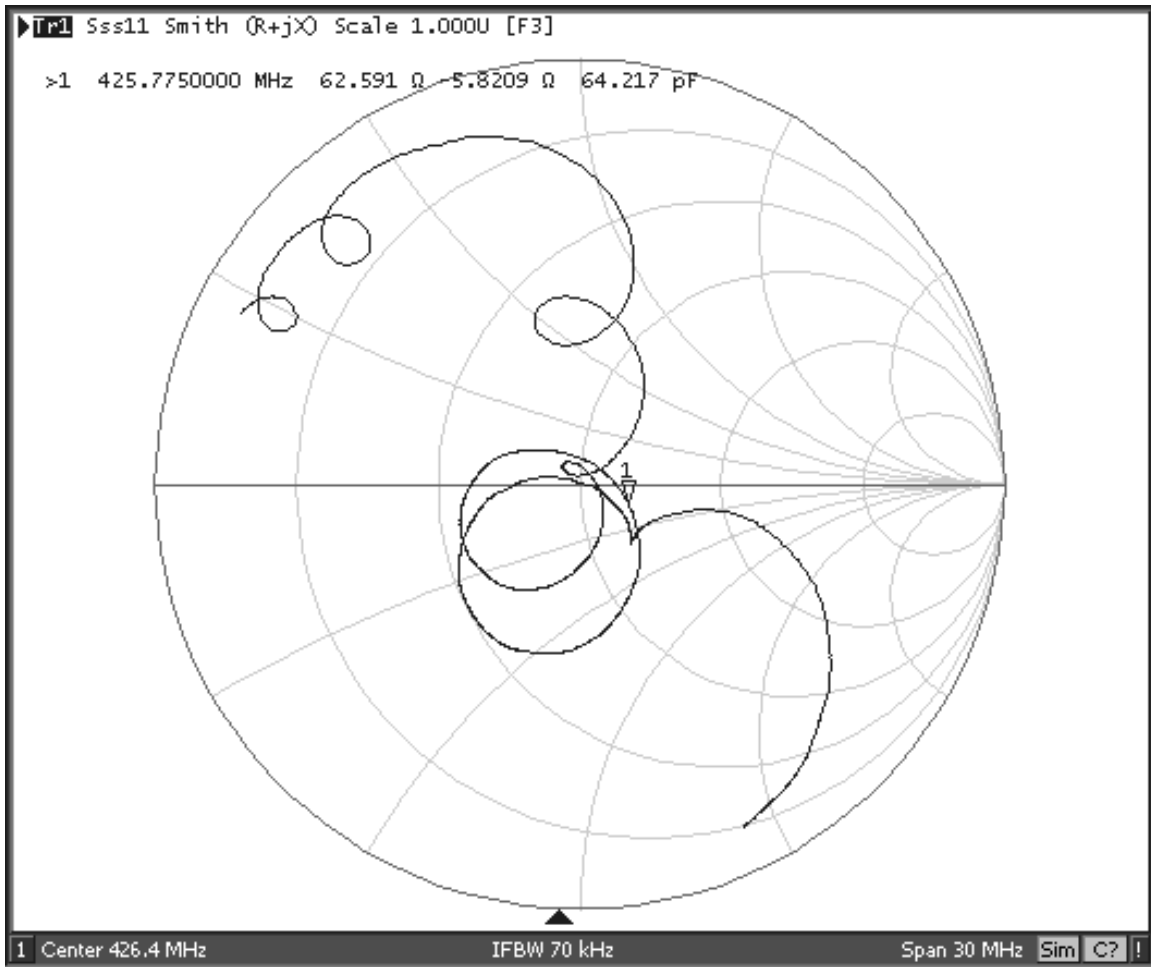
RF3608D Response, 326.4 to 526.4 MHz



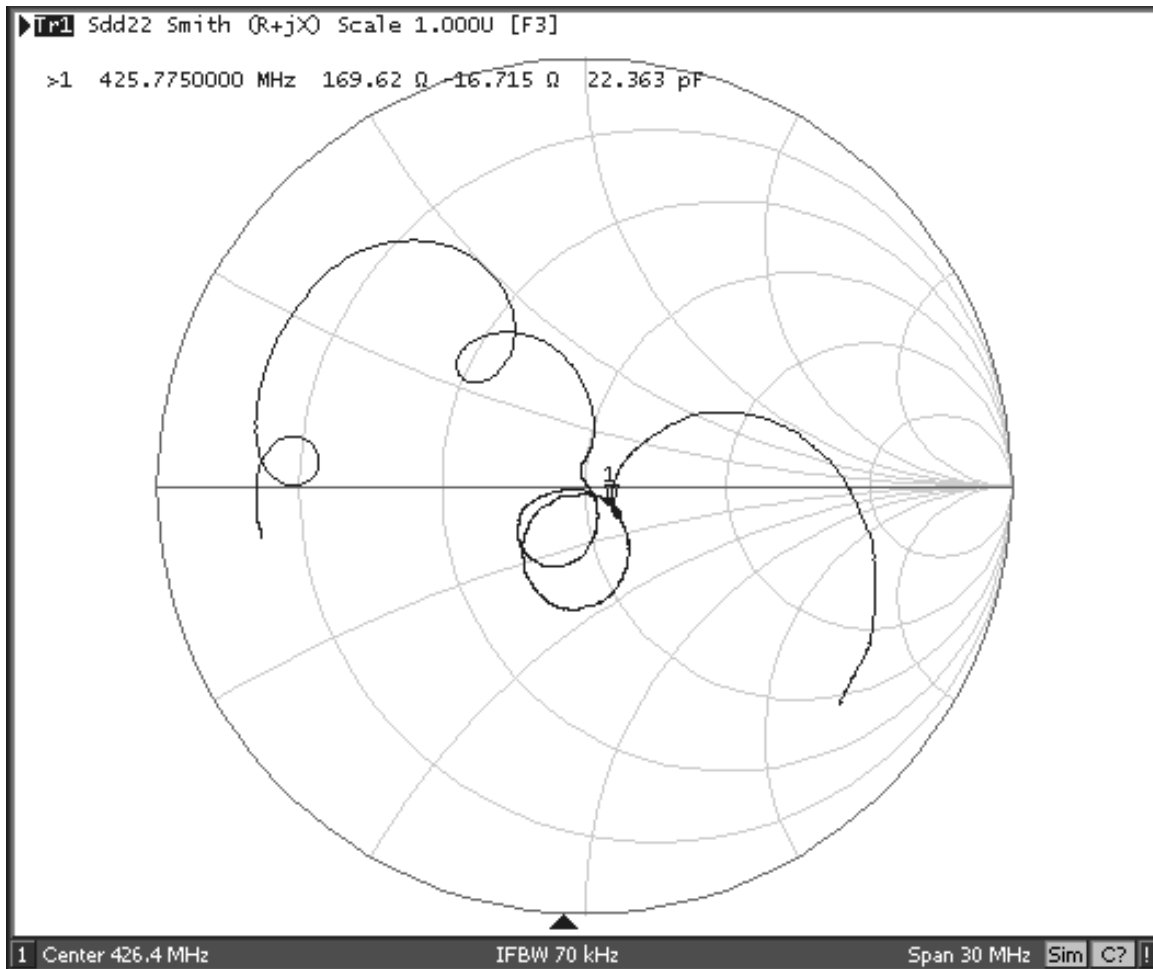
RF3608D Response, 376.4 to 476.4 MHz



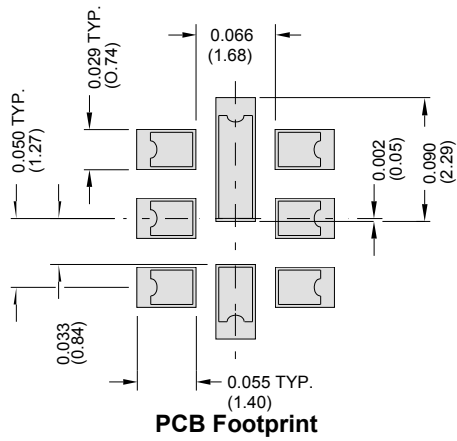
RF3608D Input Impedance Plot



RF3608D Balanced Output Impedance Plot



8-Terminal Ceramic Surface-Mount Case 3.8 X 3.8 mm Nominal Footprint



Dimension	Case Dimensions					
	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	3.6	3.8	4.0	0.142	0.150	0.157
B	3.6	3.8	4.0	0.142	0.150	0.157
C	0.90	1.00	1.1	0.035	0.040	0.043
D	0.80	0.90	1.0	0.031	0.035	0.040
E	0.90	1.00	1.10	0.035	0.040	0.043
F	0.50	0.60	0.70	0.020	0.024	0.028
G	2.39	2.54	2.69	0.090	0.100	0.110
H	1.40	1.75	2.05	0.055	0.069	0.080

Materials	
Solder Pad Plating	0.3 to 1.0 μ m Gold over 1.27 to 8.89 μ m Nickel
Lid Plating	2.0 to 3.0 μ m Nickel
Body	Al ₂ O ₃ Ceramic
Pb Free	

